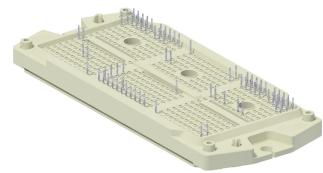


EasyPACK™ module with TRENCHSTOP™ IGBT7 and CoolSiC™ Schottky diode and PressFIT / NTC

Features

- Electrical features
 - $V_{CES} = 950 \text{ V}$
 - $I_{C\text{ nom}} = 600 \text{ A} / I_{CRM} = 800 \text{ A}$
 - CoolSiC™ Schottky diode gen 5
 - TRENCHSTOP™ IGBT7
 - $T_{vj,\text{op}} = 150^\circ\text{C}$
- Mechanical features
 - Package with CTI > 400
 - PressFIT contact technology
 - Integrated NTC temperature sensor



Potential applications

- Solar applications
- Three-level applications

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

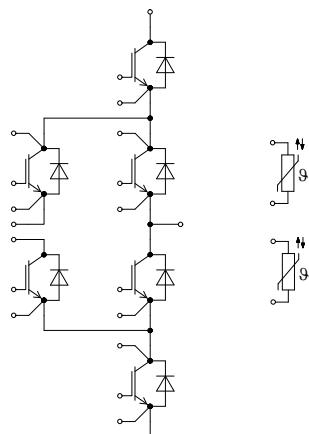


Table of contents

Description	1
Features	1
Potential applications	1
Product validation	1
Table of contents	2
1 Package	3
2 IGBT, T1 / T4	3
3 IGBT, T2 / T3	5
4 IGBT, T5 / T6	6
5 Diode, D1 / D4	8
6 Diode, D2 / D3	9
7 Diode, D5 / D6	9
8 NTC-Thermistor	10
9 Characteristics diagrams	12
10 Circuit diagram	24
11 Package outlines	25
12 Module label code	26
Revision history	27
Disclaimer	28

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values		Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	3.2		kV
Internal isolation		basic insulation (class 1, IEC 61140)	Al_2O_3		
Creepage distance	d_{Creep}	terminal to heatsink	11.0		mm
Clearance	d_{Clear}	terminal to heatsink	9.2		mm
Comparative tracking index	CTI		> 400		
Relative thermal index (electrical)	RTI	housing	140		°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{sCE}			20		nH
Module lead resistance, terminals - chip	$R_{CC'EE'}$	$T_H=25^\circ\text{C}$, per switch		1.8		mΩ
Storage temperature	T_{stg}		-40		125	°C
Terminal connection torque	M	- Mounting according to valid application note	M5, Screw	1.3	1.5	Nm
Weight	G			112		g

Note: The current under continuous operation is limited to 25A rms per connector pin.

2 IGBT, T1 / T4

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values		Unit
Collector-emitter voltage	V_{CES}	$T_{vj} = 25^\circ\text{C}$		950		V
Implemented collector current	I_{CN}			600		A
Continuous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	$T_H = 65^\circ\text{C}$	310		A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj \text{ op}}$		800		A
Gate-emitter peak voltage	V_{GES}			±20		V

Table 4 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 400 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.63	1.89
			$T_{vj} = 125^\circ\text{C}$		1.79	
			$T_{vj} = 150^\circ\text{C}$		1.82	
Gate threshold voltage	$V_{GE\text{th}}$	$I_C = 9.25 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	4.35	5.10	5.85	V
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}, V_{CE} = 600 \text{ V}$		1.35		μC
Internal gate resistor	$R_{G\text{int}}$	$T_{vj} = 25^\circ\text{C}$		0.5		Ω
Input capacitance	C_{ies}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		37.9		nF
Reverse transfer capacitance	C_{res}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		0.117		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 950 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		0.1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 5 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.145	
			$T_{vj} = 125^\circ\text{C}$		0.145	
			$T_{vj} = 150^\circ\text{C}$		0.145	
Rise time (inductive load)	t_r	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 5 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.068	
			$T_{vj} = 125^\circ\text{C}$		0.068	
			$T_{vj} = 150^\circ\text{C}$		0.068	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 18 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.914	
			$T_{vj} = 125^\circ\text{C}$		0.967	
			$T_{vj} = 150^\circ\text{C}$		0.991	
Fall time (inductive load)	t_f	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 18 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.054	
			$T_{vj} = 125^\circ\text{C}$		0.059	
			$T_{vj} = 150^\circ\text{C}$		0.061	
Turn-on energy loss per pulse	E_{on}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 5 \Omega, di/dt = 4800 \text{ A}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		19.3	
			$T_{vj} = 125^\circ\text{C}$		19.3	
			$T_{vj} = 150^\circ\text{C}$		19.3	
Turn-off energy loss per pulse	E_{off}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 18 \Omega, dv/dt = 3200 \text{ V}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		22.8	
			$T_{vj} = 125^\circ\text{C}$		24.5	
			$T_{vj} = 150^\circ\text{C}$		25.4	
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{\text{grease}} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$		0.182		K/W

(table continues...)

Table 4 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

3 IGBT, T2 / T3

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition		Values		Unit
Collector-emitter voltage	V_{CES}			$T_{vj} = 25 \text{ }^\circ\text{C}$		V
Implemented collector current	I_{CN}			400		A
Continuous DC collector current	I_{CDC}	$T_{vj\ max} = 175 \text{ }^\circ\text{C}$	$T_H = 65 \text{ }^\circ\text{C}$	320		A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\ op}$		800		A
Gate-emitter peak voltage	V_{GES}			± 20		V

Table 6 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 400 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		1.30	1.40	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$		1.35		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		1.35		
Gate threshold voltage	$V_{GE\ th}$	$I_C = 6.5 \text{ mA}, V_{CE} = 20 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$		4.15	4.90	5.65	V
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}, V_{CE} = 600 \text{ V}$			4.1		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25 \text{ }^\circ\text{C}$			0.75		Ω
Input capacitance	C_{ies}	$f = 100 \text{ kHz}, T_{vj} = 25 \text{ }^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$			49.2		nF
Reverse transfer capacitance	C_{res}	$f = 100 \text{ kHz}, T_{vj} = 25 \text{ }^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$			0.228		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 950 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$			0.1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{Gon} = 12 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.445		μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.409		
			$T_{vj} = 150 \text{ }^\circ\text{C}$		0.400		

(table continues...)

Table 6 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rise time (inductive load)	t_r	$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 12 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.099	μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.113	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		0.117	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 27 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$		2.293	μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$		2.409	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		2.439	
Fall time (inductive load)	t_f	$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 27 \Omega$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.203	μs
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.396	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		0.452	
Turn-on energy loss per pulse	E_{on}	$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $L_\sigma = 64 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Gon} = 12 \Omega$, $dI/dt = 2700 \text{ A}/\mu\text{s}$ ($T_{vj} = 150 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$		13.9	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		14.5	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		14.9	
Turn-off energy loss per pulse	E_{off}	$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $L_\sigma = 64 \text{ nH}$, $V_{GE} = \pm 15 \text{ V}$, $R_{Goff} = 27 \Omega$, $dv/dt = 2060 \text{ V}/\mu\text{s}$ ($T_{vj} = 150 \text{ }^\circ\text{C}$)	$T_{vj} = 25 \text{ }^\circ\text{C}$		60.6	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		74.3	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		78.1	
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{grease} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$			0.254	K/W
Temperature under switching conditions	$T_{vj\ op}$			-40	150	$^\circ\text{C}$

4 IGBT, T5 / T6

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition		Values		Unit
Collector-emitter voltage	V_{CES}			$T_{vj} = 25 \text{ }^\circ\text{C}$	950	V
Implemented collector current	I_{CN}				400	A
Continuous DC collector current	I_{CDC}	$T_{vj\ max} = 175 \text{ }^\circ\text{C}$	$T_H = 65 \text{ }^\circ\text{C}$		200	A
Repetitive peak collector current	I_{CRM}	t_p limited by $T_{vj\ op}$			800	A
Gate-emitter peak voltage	V_{GES}				± 20	V

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C = 400 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1.85	2.25
			$T_{vj} = 125^\circ\text{C}$		2.10	
			$T_{vj} = 150^\circ\text{C}$		2.15	
Gate threshold voltage	$V_{GE\text{th}}$	$I_C = 6.5 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	4.35	5.10	5.85	V
Gate charge	Q_G	$V_{GE} = \pm 15 \text{ V}, V_{CE} = 600 \text{ V}$		0.9		μC
Internal gate resistor	$R_{G\text{int}}$	$T_{vj} = 25^\circ\text{C}$		0.75		Ω
Input capacitance	C_{ies}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		25.2		nF
Reverse transfer capacitance	C_{res}	$f = 100 \text{ kHz}, T_{vj} = 25^\circ\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$		0.078		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 950 \text{ V}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$		1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$			100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.167	
			$T_{vj} = 125^\circ\text{C}$		0.169	
			$T_{vj} = 150^\circ\text{C}$		0.170	
Rise time (inductive load)	t_r	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.096	
			$T_{vj} = 125^\circ\text{C}$		0.102	
			$T_{vj} = 150^\circ\text{C}$		0.104	
Turn-off delay time (inductive load)	t_{doff}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 27 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.862	
			$T_{vj} = 125^\circ\text{C}$		0.919	
			$T_{vj} = 150^\circ\text{C}$		0.940	
Fall time (inductive load)	t_f	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 27 \Omega$	$T_{vj} = 25^\circ\text{C}$		0.054	
			$T_{vj} = 125^\circ\text{C}$		0.058	
			$T_{vj} = 150^\circ\text{C}$		0.060	
Turn-on energy loss per pulse	E_{on}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{on}} = 8 \Omega, \text{di/dt} = 3100 \text{ A}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		40.8	
			$T_{vj} = 125^\circ\text{C}$		38	
			$T_{vj} = 150^\circ\text{C}$		37.8	
Turn-off energy loss per pulse	E_{off}	$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, L_\sigma = 35 \text{ nH}, V_{GE} = \pm 15 \text{ V}, R_{G\text{off}} = 27 \Omega, \text{dv/dt} = 3050 \text{ V}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$		25.2	
			$T_{vj} = 125^\circ\text{C}$		28	
			$T_{vj} = 150^\circ\text{C}$		29.1	
Thermal resistance, junction to heat sink	R_{thJH}	per IGBT, $\lambda_{\text{grease}} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$		0.281		K/W

(table continues...)

Table 8 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

5 Diode, D1 / D4

Table 9 Maximum rated values

Parameter	Symbol	Note or test condition	Values			Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25 \text{ }^\circ\text{C}$	950		V
Continuous DC forward current	I_F			300		A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$		600		A
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	3100		A^2s
			$T_{vj} = 150 \text{ }^\circ\text{C}$	2900		

Table 10 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 300 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$	2.60	2.90	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$	2.40		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	2.35		
Peak reverse recovery current	I_{RM}	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$	102		A
			$T_{vj} = 125 \text{ }^\circ\text{C}$	147		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	163		
Recovered charge	Q_r	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$	11.3		μC
			$T_{vj} = 125 \text{ }^\circ\text{C}$	20.3		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	24.1		
Reverse recovery energy	E_{rec}	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3000 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$	3.37		mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$	5.93		
			$T_{vj} = 150 \text{ }^\circ\text{C}$	7.06		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$		0.597		K/W
Temperature under switching conditions	$T_{vj\ op}$		-40		150	°C

6 Diode, D2 / D3

Table 11 Maximum rated values

Parameter	Symbol	Note or test condition	Values		Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25^\circ\text{C}$		950
Continuous DC forward current	I_F				300
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$			600
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125^\circ\text{C}$	3100	A^2s
			$T_{vj} = 150^\circ\text{C}$	2900	

Table 12 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 300 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25^\circ\text{C}$	2.60	2.90	V
			$T_{vj} = 125^\circ\text{C}$	2.40		
			$T_{vj} = 150^\circ\text{C}$	2.35		
Peak reverse recovery current	I_{RM}	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 2200 \text{ A}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$	146		A
			$T_{vj} = 125^\circ\text{C}$	194		
			$T_{vj} = 150^\circ\text{C}$	207		
Recovered charge	Q_r	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 2200 \text{ A}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$	8.45		μC
			$T_{vj} = 125^\circ\text{C}$	17.9		
			$T_{vj} = 150^\circ\text{C}$	21.3		
Reverse recovery energy	E_{rec}	$V_R = 500 \text{ V}, I_F = 300 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 2200 \text{ A}/\mu\text{s} (T_{vj} = 150^\circ\text{C})$	$T_{vj} = 25^\circ\text{C}$	4.22		mJ
			$T_{vj} = 125^\circ\text{C}$	8.19		
			$T_{vj} = 150^\circ\text{C}$	9.6		
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$		0.393		K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	°C

7 Diode, D5 / D6

Table 13 Maximum rated values

Parameter	Symbol	Note or test condition	Values		Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25^\circ\text{C}$		1200

(table continues...)

Table 13 (continued) Maximum rated values

Parameter	Symbol	Note or test condition	Values		Unit
Continuous DC forward current	I_F			160	A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$			A
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ }^\circ\text{C}$	3050	A^2s
			$T_{vj} = 150 \text{ }^\circ\text{C}$	2780	

Table 14 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 160 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ }^\circ\text{C}$		1.45	V
			$T_{vj} = 125 \text{ }^\circ\text{C}$		1.75	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		1.85	
Peak reverse recovery current	I_{RM}	$V_R = 500 \text{ V}, I_F = 160 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		71.4	A
			$T_{vj} = 125 \text{ }^\circ\text{C}$		71.4	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		71.4	
Recovered charge	Q_r	$V_R = 500 \text{ V}, I_F = 160 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		1.29	μC
			$T_{vj} = 125 \text{ }^\circ\text{C}$		1.29	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		1.29	
Reverse recovery energy	E_{rec}	$V_R = 500 \text{ V}, I_F = 160 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 3500 \text{ A}/\mu\text{s} (T_{vj} = 150 \text{ }^\circ\text{C})$	$T_{vj} = 25 \text{ }^\circ\text{C}$		0.66	mJ
			$T_{vj} = 125 \text{ }^\circ\text{C}$		0.66	
			$T_{vj} = 150 \text{ }^\circ\text{C}$		0.66	
Thermal resistance, junction to heat sink	R_{thJH}	per diode, $\lambda_{grease} = 3.3 \text{ W}/(\text{m}\cdot\text{K})$			0.430	K/W
Temperature under switching conditions	$T_{vj op}$		-40		150	${}^\circ\text{C}$

8 NTC-Thermistor

Table 15 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$		5		k Ω
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100 \text{ }^\circ\text{C}, R_{100} = 493 \Omega$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25 \text{ }^\circ\text{C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15 \text{ K}))]$		3375		K

(table continues...)

Table 15 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15 K))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15 K))]$		3433		K

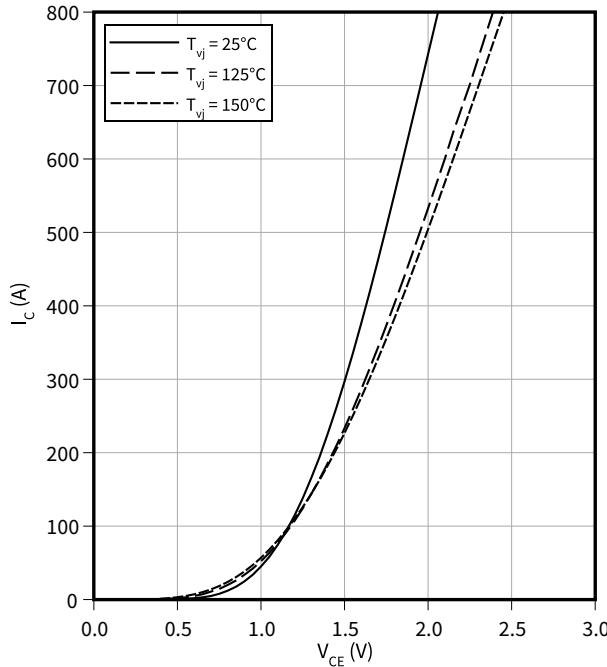
Note: Specification according to the valid application note.

9 Characteristics diagrams

Output characteristic (typical), IGBT, T1 / T4

$I_C = f(V_{CE})$

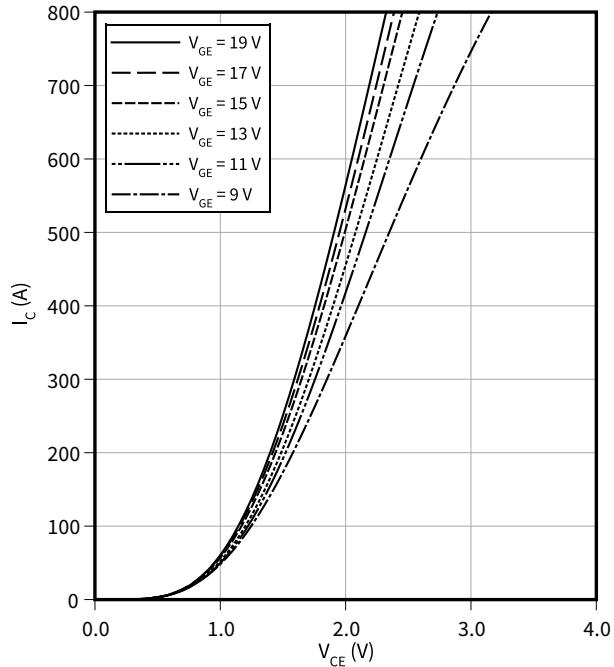
$V_{GE} = 15 \text{ V}$



Output characteristic field (typical), IGBT, T1 / T4

$I_C = f(V_{CE})$

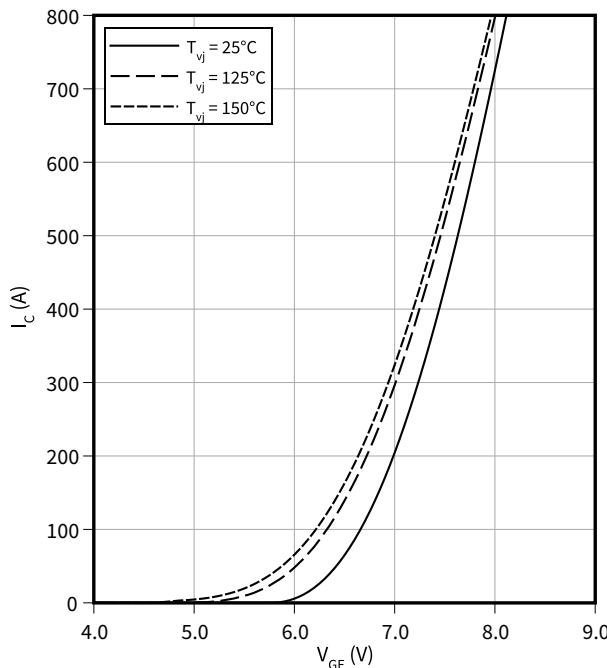
$T_{vj} = 150^\circ\text{C}$



Transfer characteristic (typical), IGBT, T1 / T4

$I_C = f(V_{GE})$

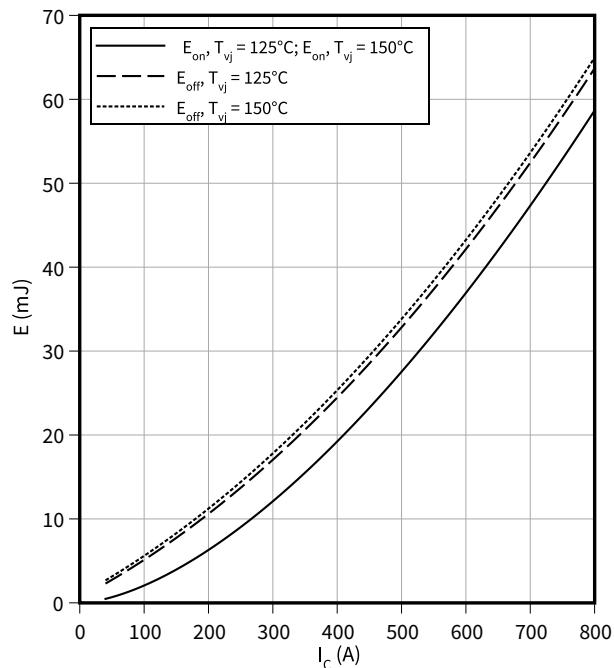
$V_{CE} = 20 \text{ V}$



Switching losses (typical), IGBT, T1 / T4

$E = f(I_C)$

$R_{Goff} = 18 \Omega$, $R_{Gon} = 5 \Omega$, $V_{CE} = 500 \text{ V}$, $V_{GE} = -15 / 15 \text{ V}$

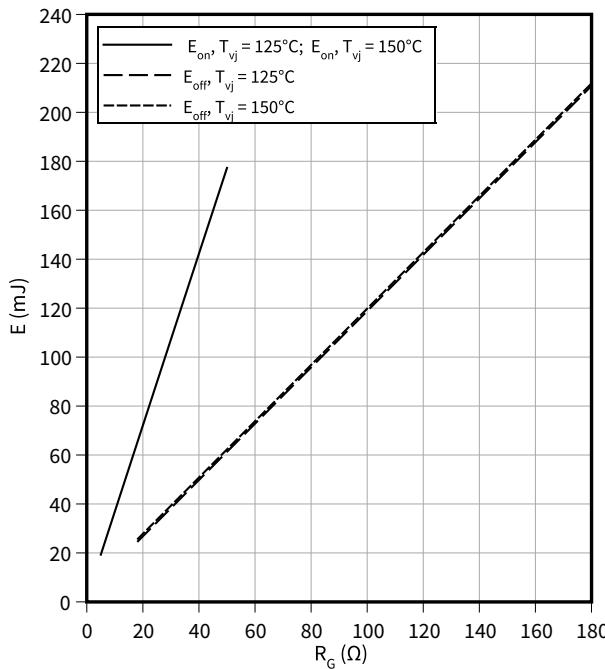


9 Characteristics diagrams

Switching losses (typical), IGBT, T1 / T4

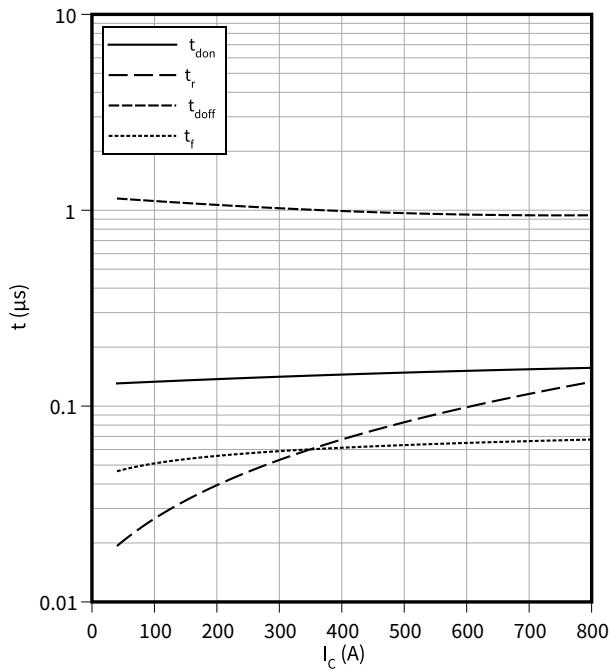
$$E = f(R_G)$$

$$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = -15 / 15 \text{ V}$$

**Switching times (typical), IGBT, T1 / T4**

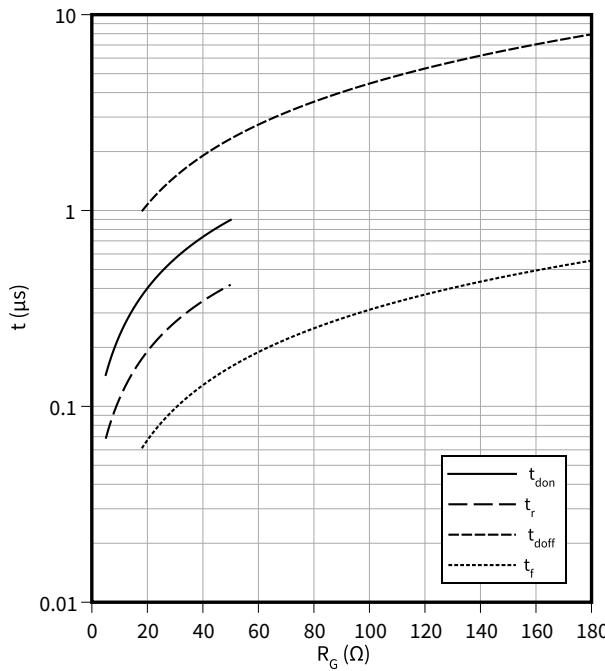
$$t = f(I_C)$$

$$R_{Goff} = 18 \Omega, R_{Gon} = 5 \Omega, V_{GE} = \pm 15 \text{ V}, V_{CE} = 500 \text{ V}, T_{vj} = 150 \text{ }^{\circ}\text{C}$$

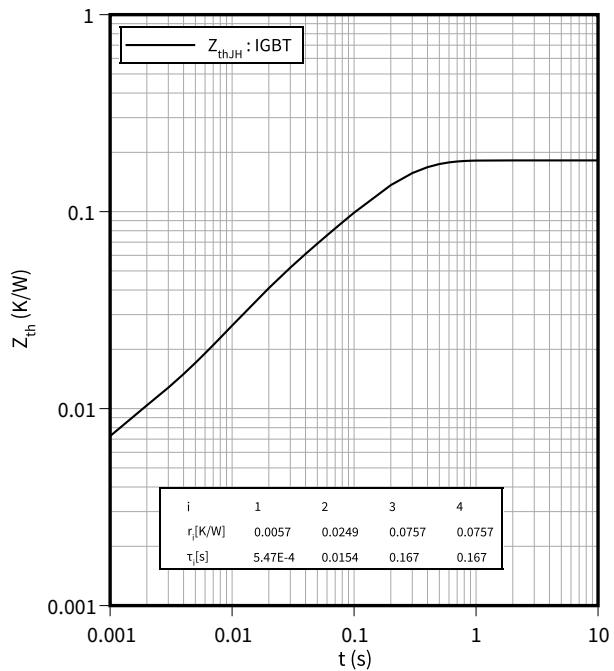
**Switching times (typical), IGBT, T1 / T4**

$$t = f(R_G)$$

$$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = -15 / 15 \text{ V}, T_{vj} = 150 \text{ }^{\circ}\text{C}$$

**Transient thermal impedance , IGBT, T1 / T4**

$$Z_{th} = f(t)$$

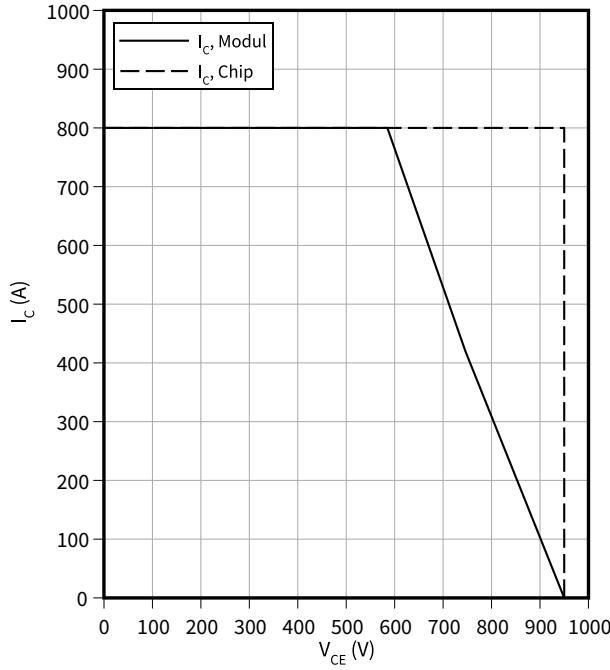


9 Characteristics diagrams

Reverse bias safe operating area (RBSOA), IGBT, T1 / T4

$$I_C = f(V_{CE})$$

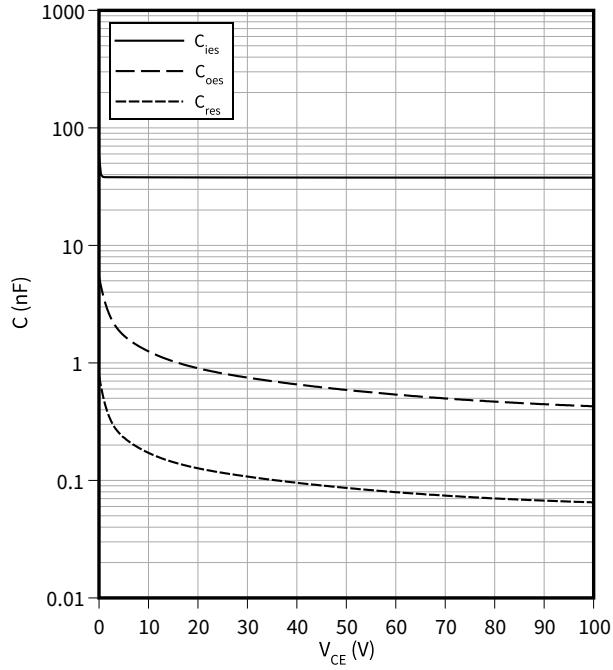
$R_{Goff} = 18 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $T_{vj} = 150^\circ\text{C}$



Capacity characteristic (typical), IGBT, T1 / T4

$$C = f(V_{CE})$$

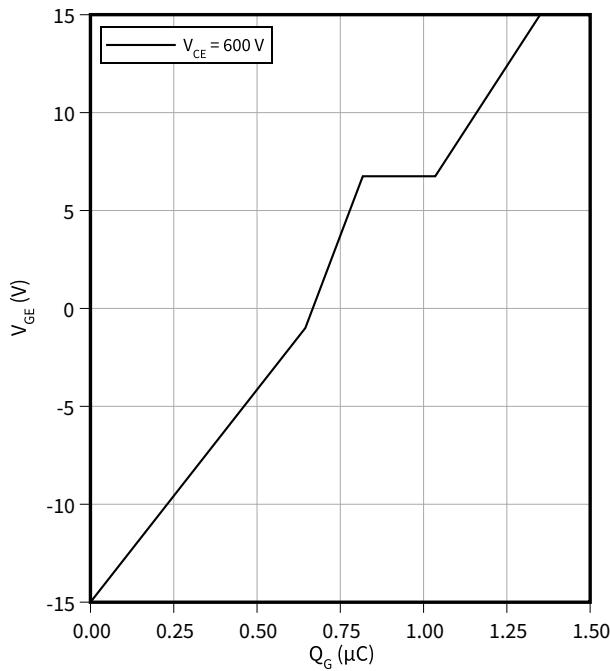
$f = 100 \text{ kHz}$, $V_{GE} = 0 \text{ V}$, $T_{vj} = 25^\circ\text{C}$



Gate charge characteristic (typical), IGBT, T1 / T4

$$V_{GE} = f(Q_G)$$

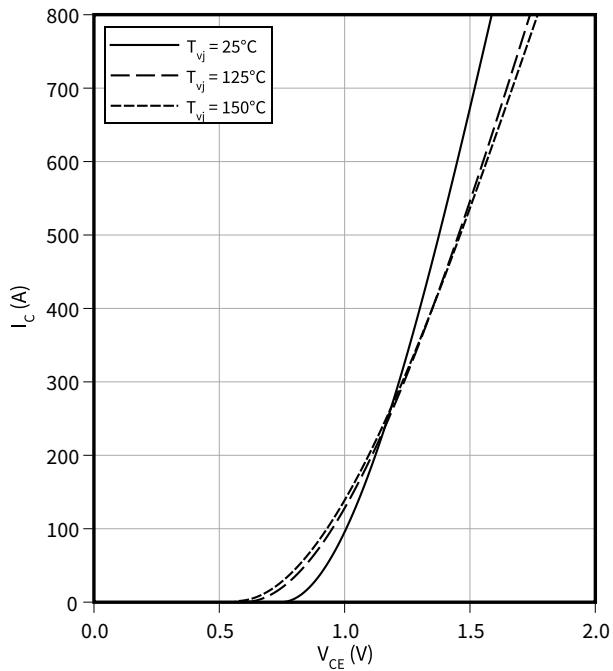
$I_C = 600 \text{ A}$, $T_{vj} = 25^\circ\text{C}$



Output characteristic (typical), IGBT, T2 / T3

$$I_C = f(V_{CE})$$

$V_{GE} = 15 \text{ V}$

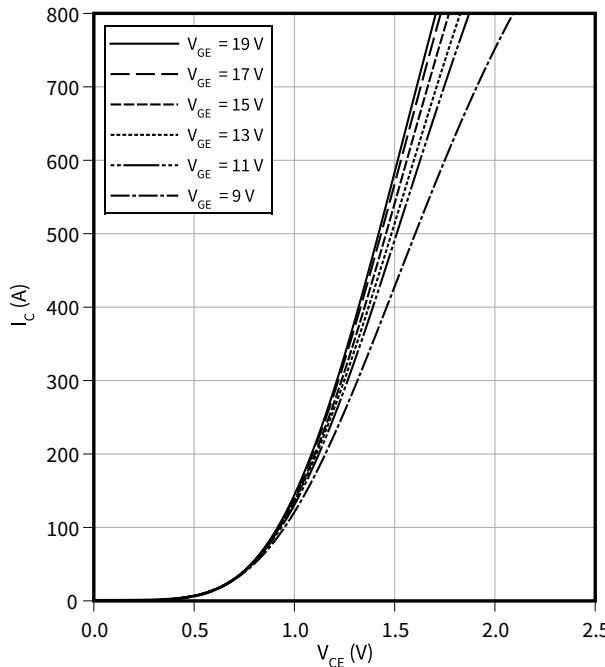


9 Characteristics diagrams

Output characteristic field (typical), IGBT, T2 / T3

$$I_C = f(V_{CE})$$

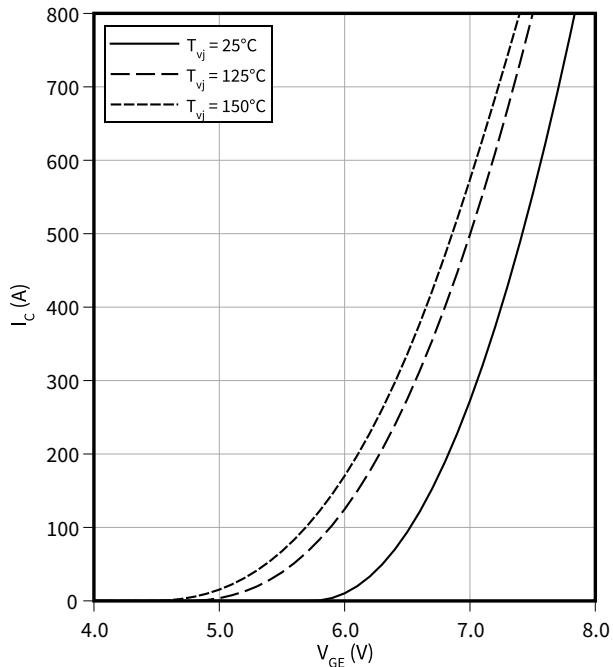
$T_{vj} = 150^\circ\text{C}$



Transfer characteristic (typical), IGBT, T2 / T3

$$I_C = f(V_{GE})$$

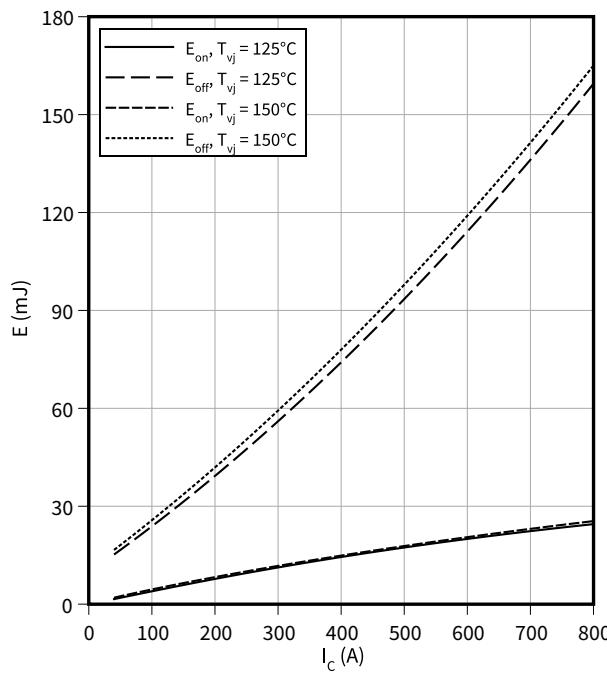
$V_{CE} = 20\text{ V}$



Switching losses (typical), IGBT, T2 / T3

$$E = f(I_C)$$

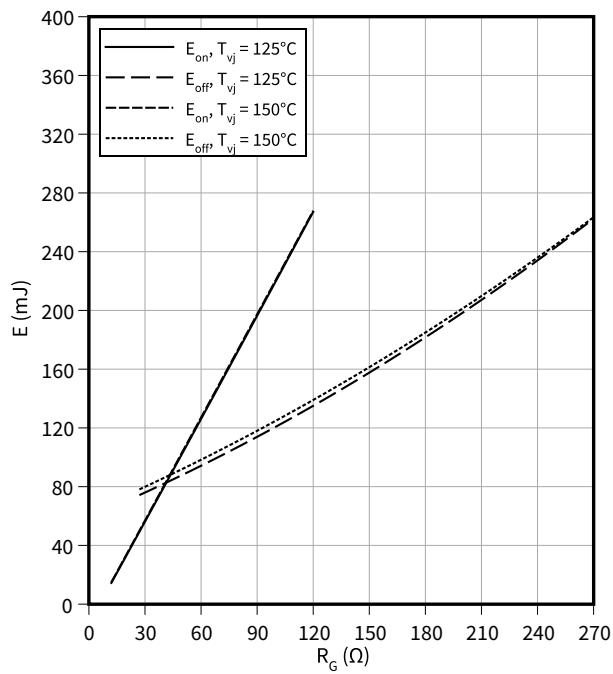
$R_{Goff} = 27\ \Omega$, $R_{Gon} = 12\ \Omega$, $V_{CE} = 500\text{ V}$, $V_{GE} = -15 / 15\text{ V}$



Switching losses (typical), IGBT, T2 / T3

$$E = f(R_G)$$

$I_C = 400\text{ A}$, $V_{CE} = 500\text{ V}$, $V_{GE} = -15 / 15\text{ V}$

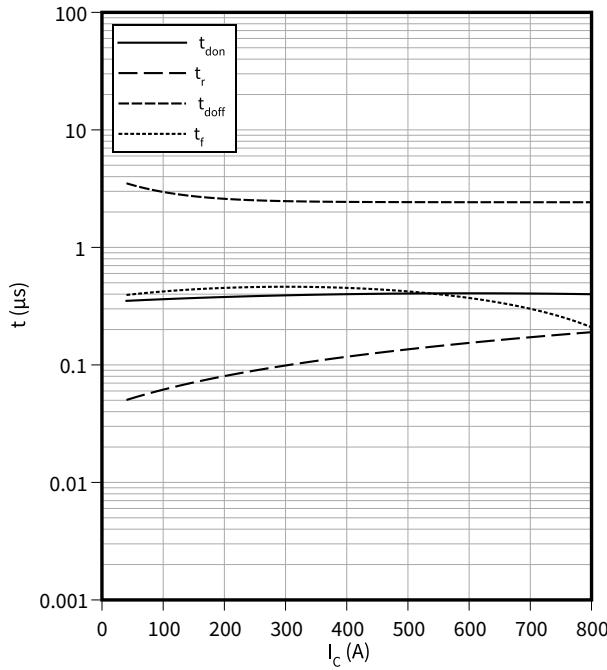


9 Characteristics diagrams

Switching times (typical), IGBT, T2 / T3

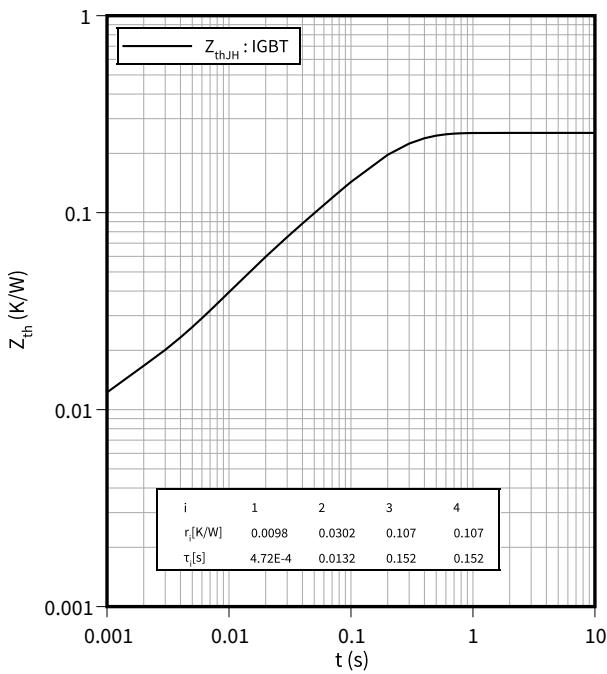
$$t = f(I_C)$$

$R_{Goff} = 27 \Omega$, $R_{Gon} = 12 \Omega$, $V_{CE} = 500 \text{ V}$, $V_{GE} = -15 / 15 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$



Transient thermal impedance , IGBT, T2 / T3

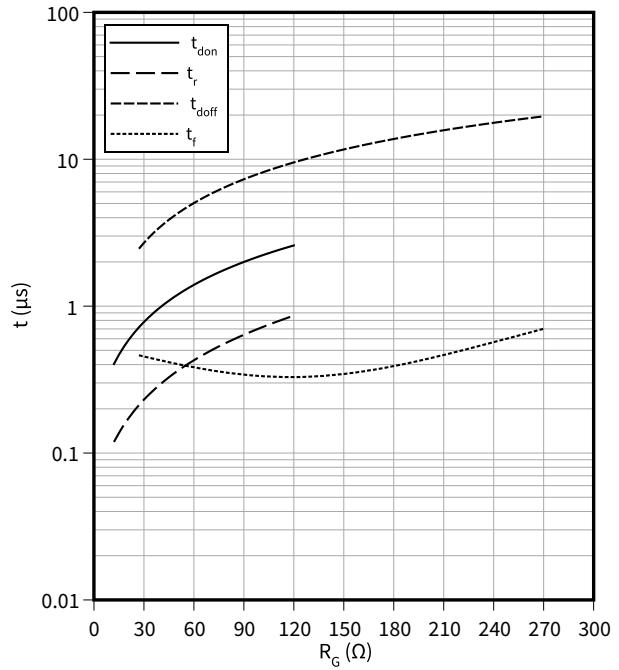
$$Z_{th} = f(t)$$



Switching times (typical), IGBT, T2 / T3

$$t = f(R_G)$$

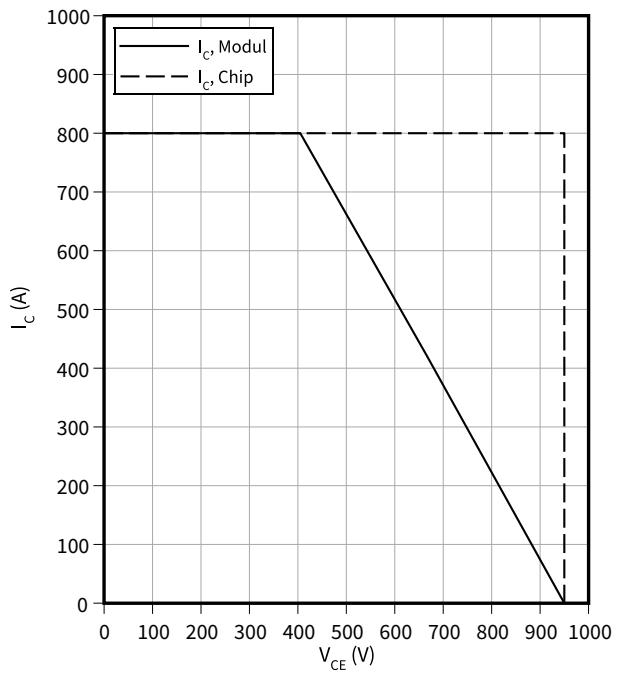
$I_C = 400 \text{ A}$, $V_{CE} = 500 \text{ V}$, $V_{GE} = -15 / 15 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$



Reverse bias safe operating area (RBSOA), IGBT, T2 / T3

$$I_C = f(V_{CE})$$

$R_{Goff} = 27 \Omega$, $V_{GE} = \pm 15 \text{ V}$, $T_{vj} = 150 \text{ }^{\circ}\text{C}$

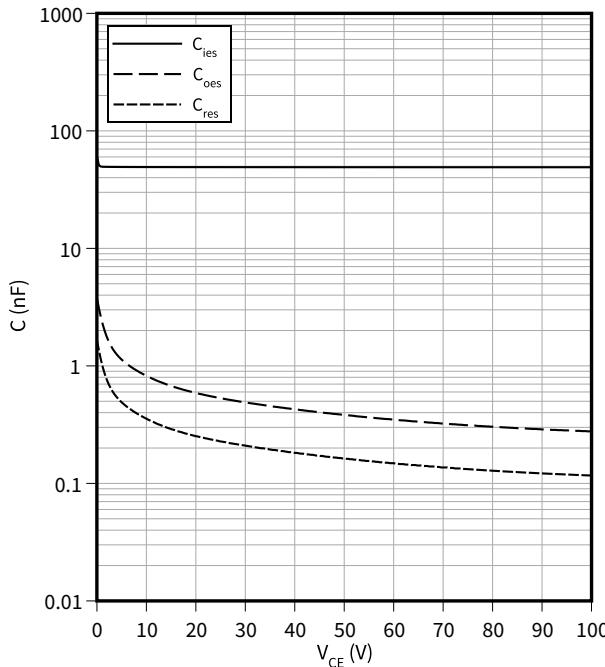


9 Characteristics diagrams

Capacity characteristic (typical), IGBT, T2 / T3

$$C = f(V_{CE})$$

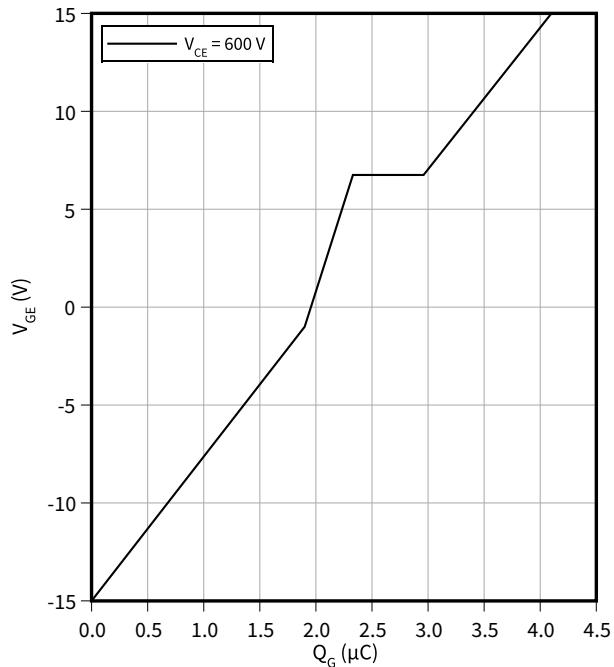
$$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}, T_{vj} = 25^\circ\text{C}$$



Gate charge characteristic (typical), IGBT, T2 / T3

$$V_{GE} = f(Q_G)$$

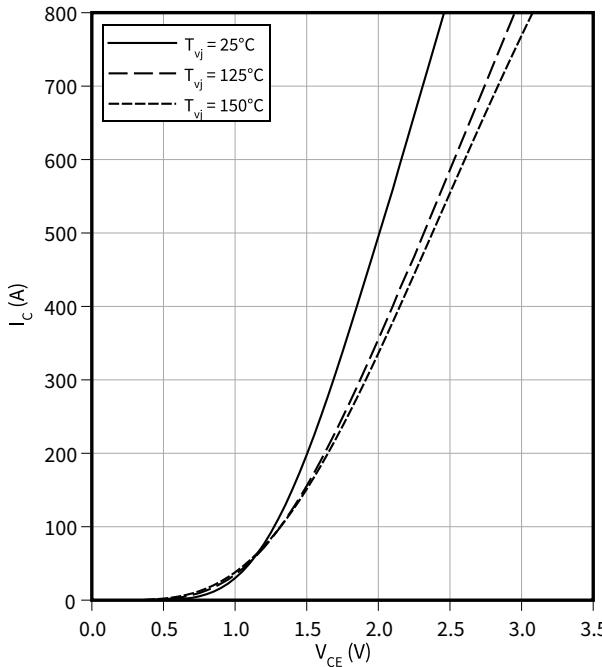
$$I_C = 400 \text{ A}, T_{vj} = 25^\circ\text{C}$$



Output characteristic (typical), IGBT, T5 / T6

$$I_C = f(V_{CE})$$

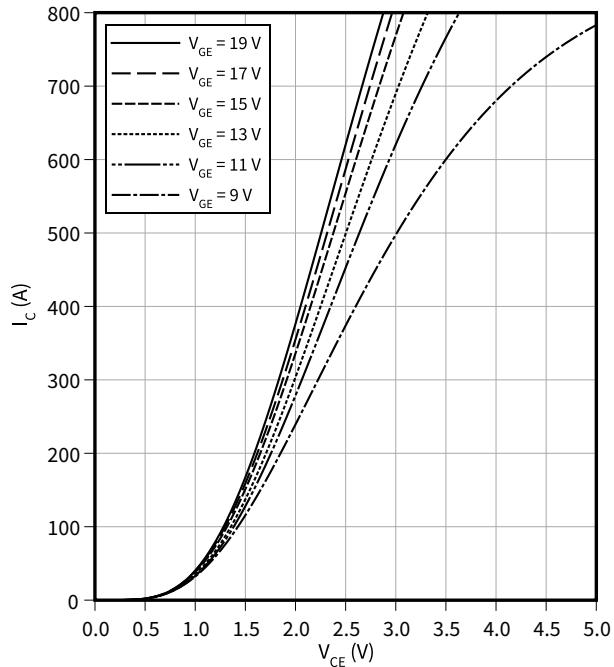
$$V_{GE} = 15 \text{ V}$$



Output characteristic field (typical), IGBT, T5 / T6

$$I_C = f(V_{CE})$$

$$T_{vj} = 150^\circ\text{C}$$

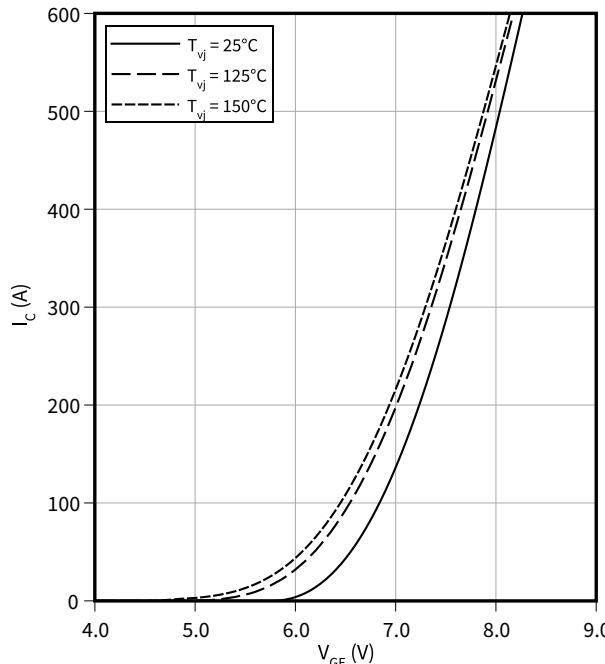


9 Characteristics diagrams

Transfer characteristic (typical), IGBT, T5 / T6

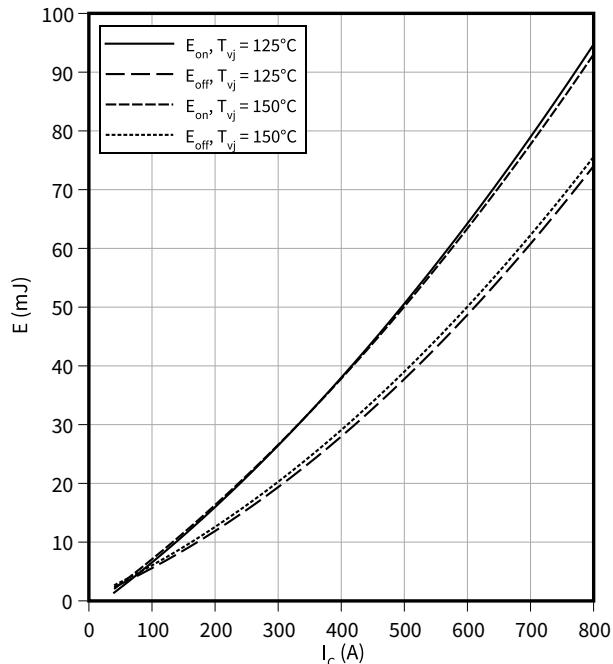
$$I_C = f(V_{GE})$$

$$V_{CE} = 20 \text{ V}$$

**Switching losses (typical), IGBT, T5 / T6**

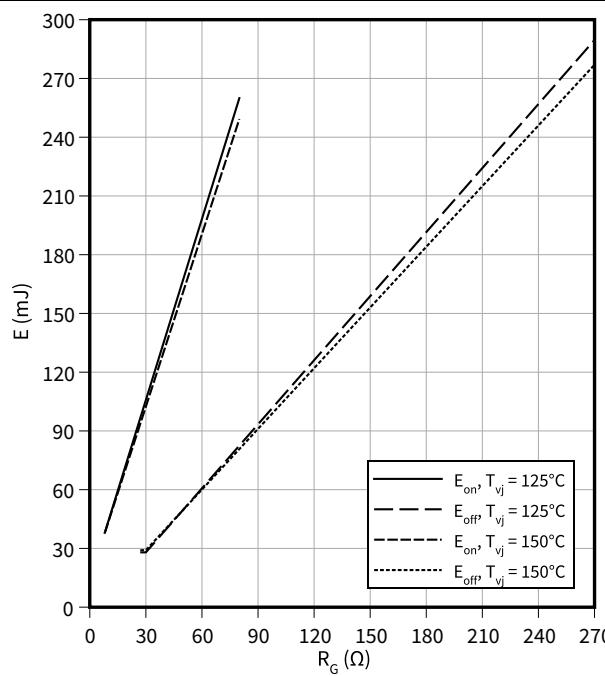
$$E = f(I_C)$$

$$R_{Goff} = 27 \Omega, R_{Gon} = 8 \Omega, V_{CE} = 500 \text{ V}, V_{GE} = -15 / 15 \text{ V}$$

**Switching losses (typical), IGBT, T5 / T6**

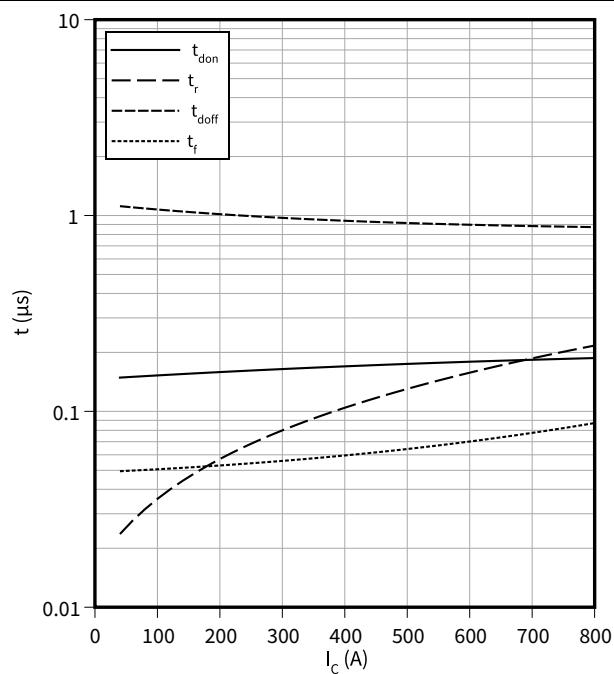
$$E = f(R_G)$$

$$I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, V_{GE} = -15 / 15 \text{ V}$$

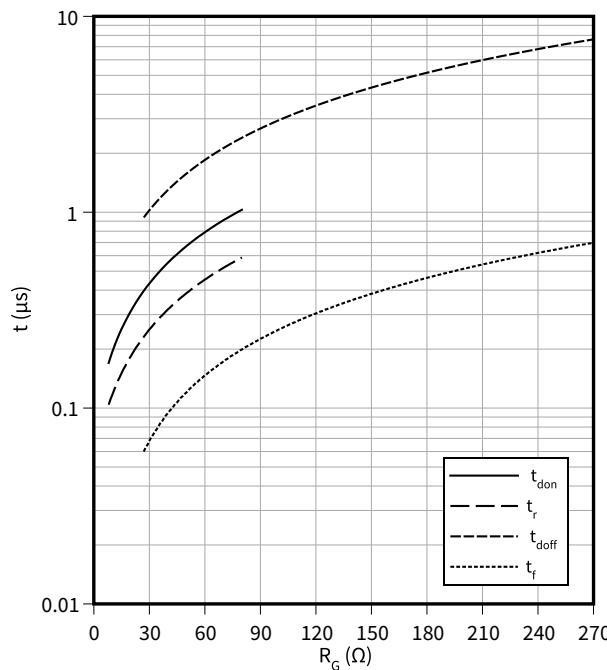
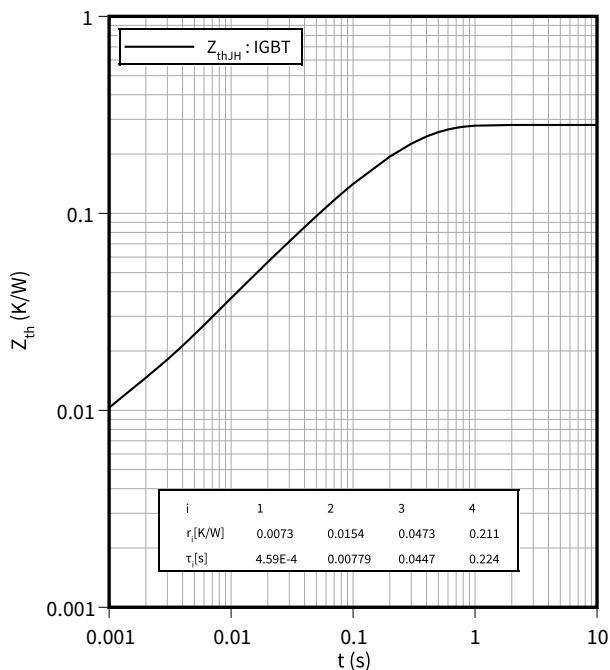
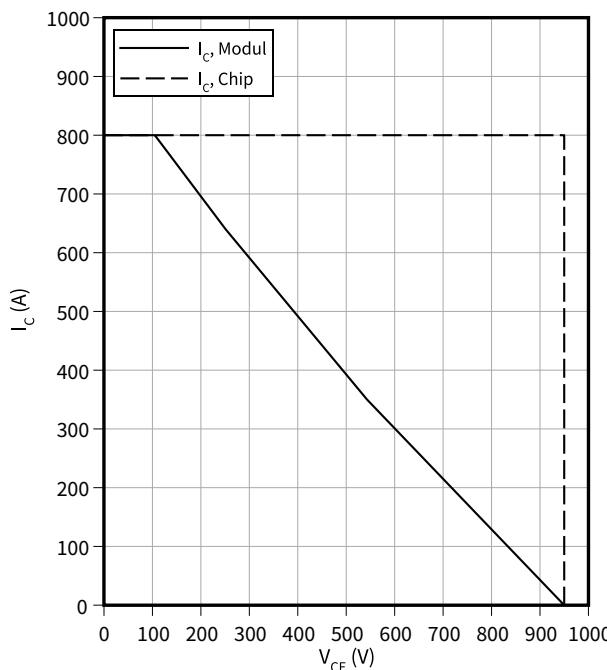
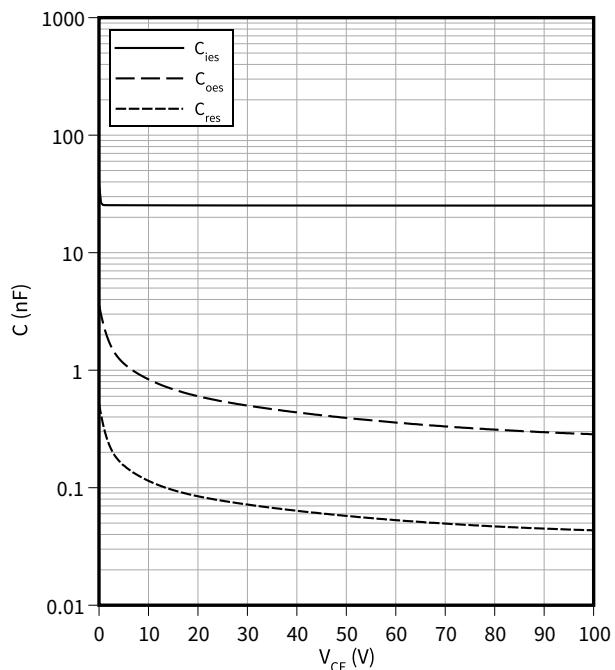
**Switching times (typical), IGBT, T5 / T6**

$$t = f(I_C)$$

$$R_{Goff} = 27 \Omega, R_{Gon} = 8 \Omega, V_{GE} = \pm 15 \text{ V}, V_{CE} = 500 \text{ V}, T_{vj} = 150^\circ\text{C}$$



9 Characteristics diagrams

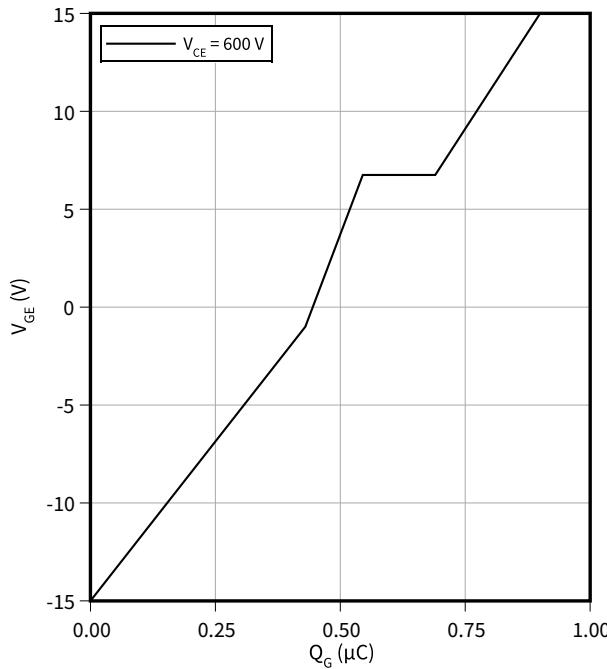
Switching times (typical), IGBT, T5 / T6 $t = f(R_G)$ $I_C = 400 \text{ A}, V_{CE} = 500 \text{ V}, T_{vj} = 150^\circ\text{C}, V_{GE} = \pm 15 \text{ V}$ **Transient thermal impedance , IGBT, T5 / T6** $Z_{th} = f(t)$ **Reverse bias safe operating area (RBSOA), IGBT, T5 / T6** $I_C = f(V_{CE})$ $R_{Goff} = 27 \Omega, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150^\circ\text{C}$ **Capacity characteristic (typical), IGBT, T5 / T6** $C = f(V_{CE})$ $f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}, T_{vj} = 25^\circ\text{C}$ 

9 Characteristics diagrams

Gate charge characteristic (typical), IGBT, T5 / T6

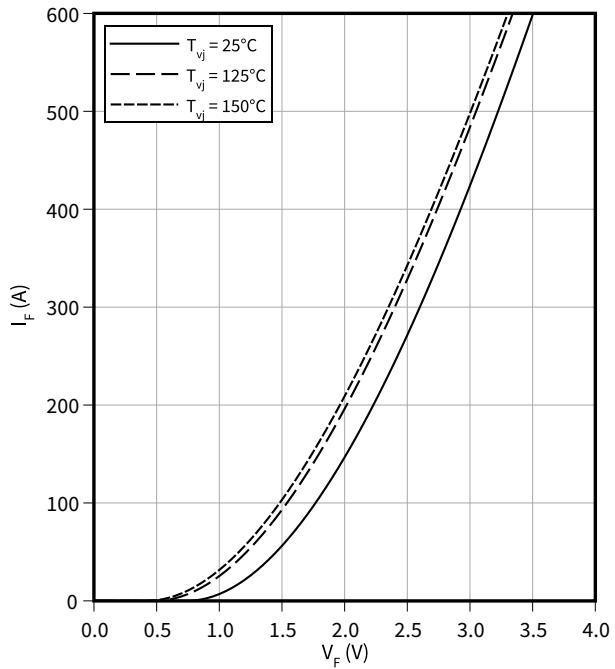
$$V_{GE} = f(Q_G)$$

$$I_C = 400 \text{ A}, T_{vj} = 25^\circ\text{C}$$



Forward characteristic (typical), Diode, D1 / D4

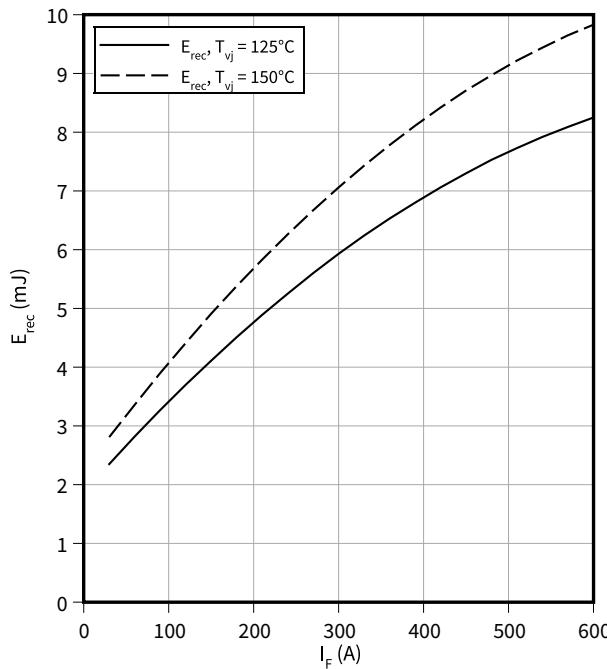
$$I_F = f(V_F)$$



Switching losses (typical), Diode, D1 / D4

$$E_{rec} = f(I_F)$$

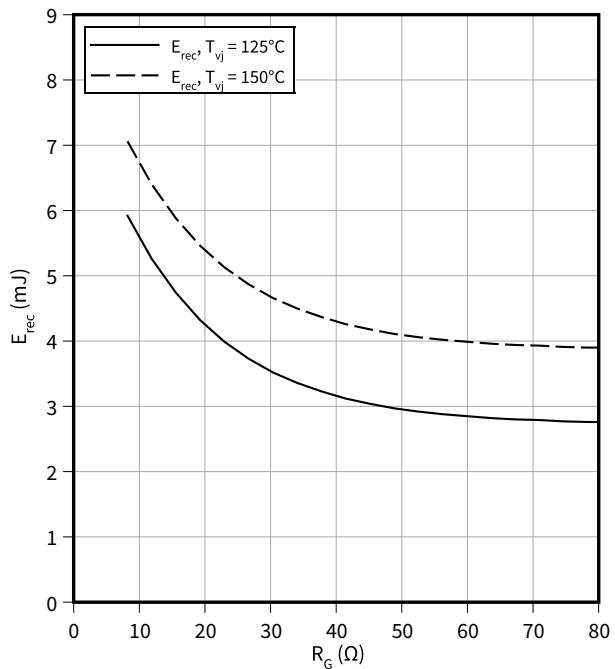
$$R_G = 8 \Omega, V_R = 500 \text{ V}$$



Switching losses (typical), Diode, D1 / D4

$$E_{rec} = f(R_G)$$

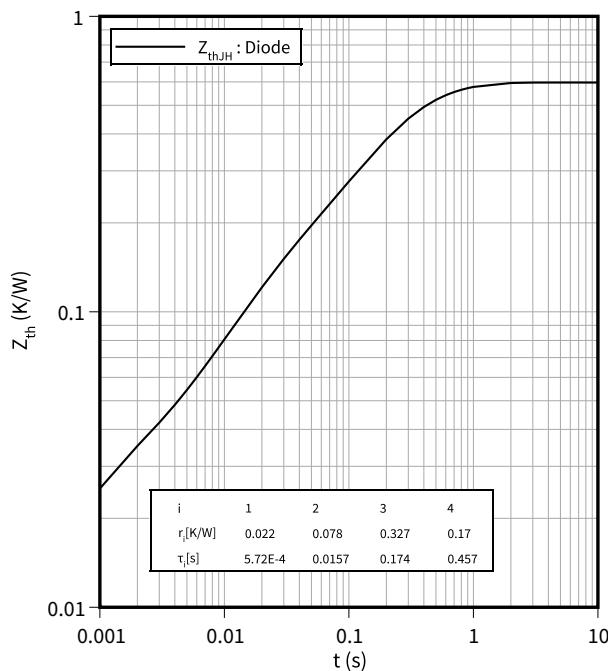
$$I_F = 300 \text{ A}, V_R = 500 \text{ V}$$



9 Characteristics diagrams

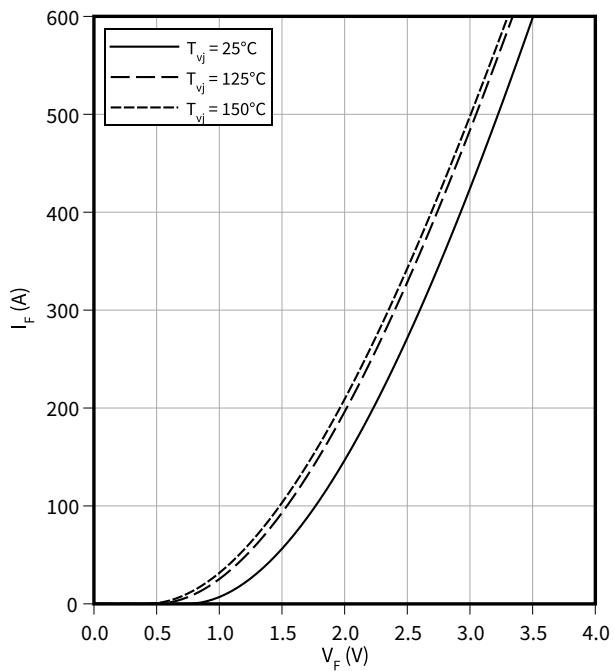
Transient thermal impedance, Diode, D1 / D4

$$Z_{th} = f(t)$$



Forward characteristic (typical), Diode, D2 / D3

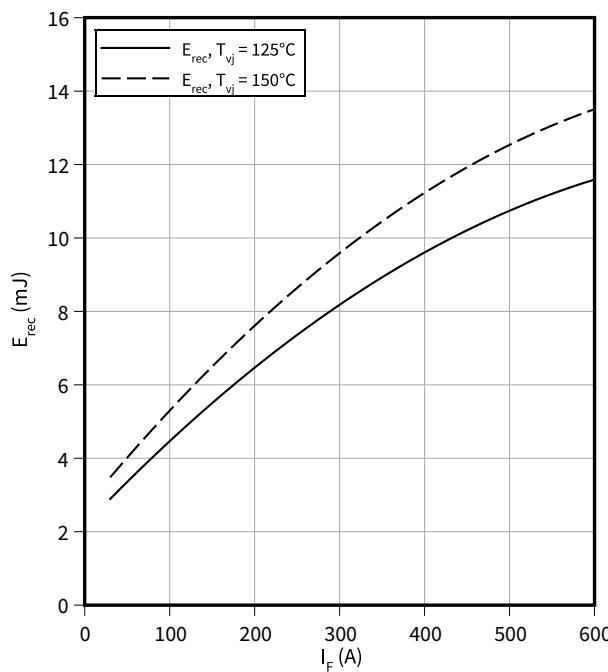
$$I_F = f(V_F)$$



Switching losses (typical), Diode, D2 / D3

$$E_{rec} = f(I_F)$$

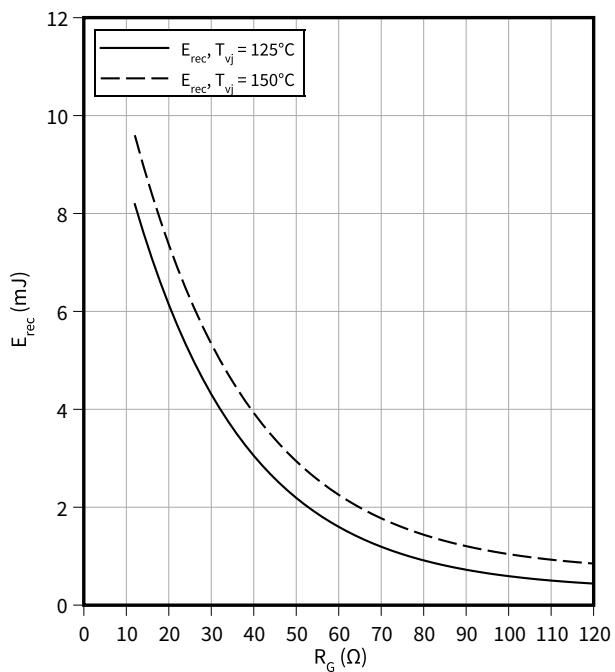
$$R_G = 12 \Omega, V_R = 500 \text{ V}$$



Switching losses (typical), Diode, D2 / D3

$$E_{rec} = f(R_G)$$

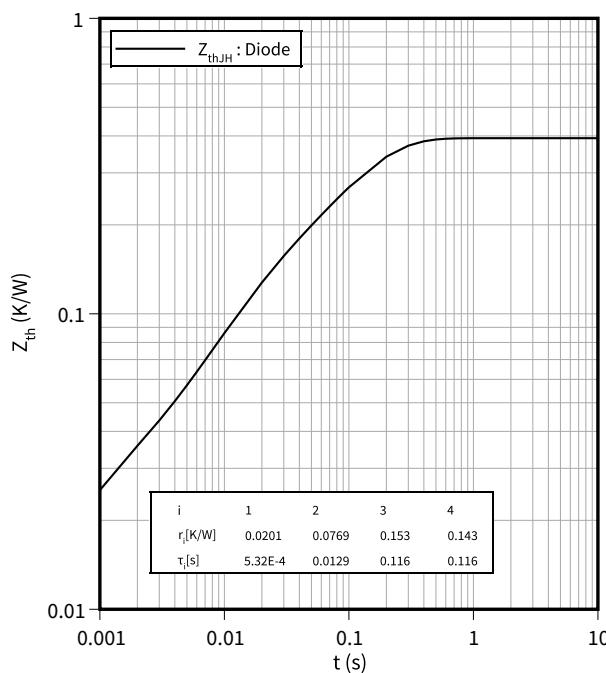
$$I_F = 300 \text{ A}, V_R = 500 \text{ V}$$



9 Characteristics diagrams

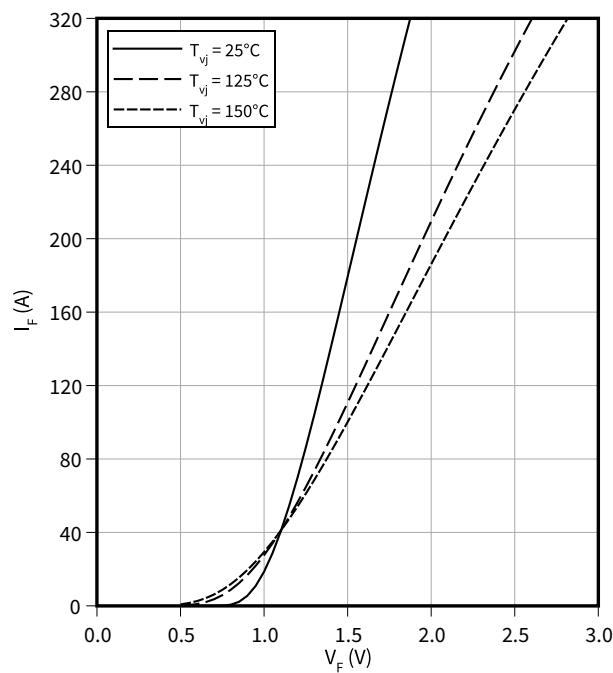
Transient thermal impedance, Diode, D2 / D3

$$Z_{th} = f(t)$$



Forward characteristic (typical), Diode, D5 / D6

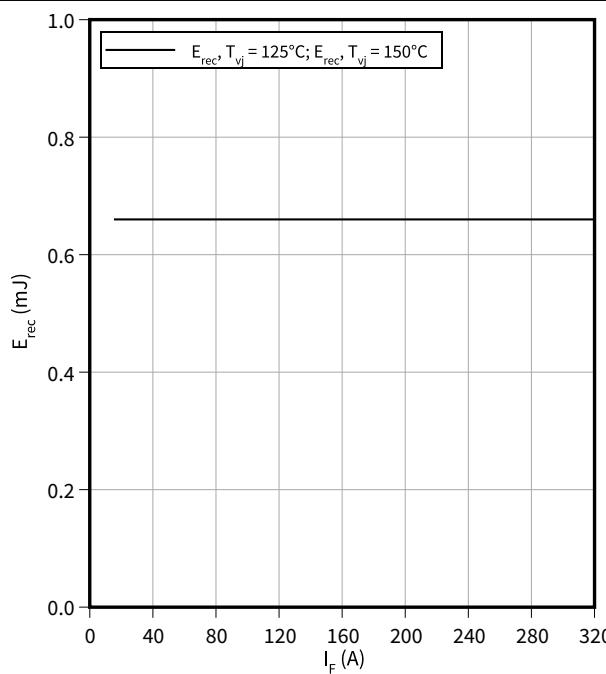
$$I_F = f(V_F)$$



Switching losses (typical), Diode, D5 / D6

$$E_{rec} = f(I_F)$$

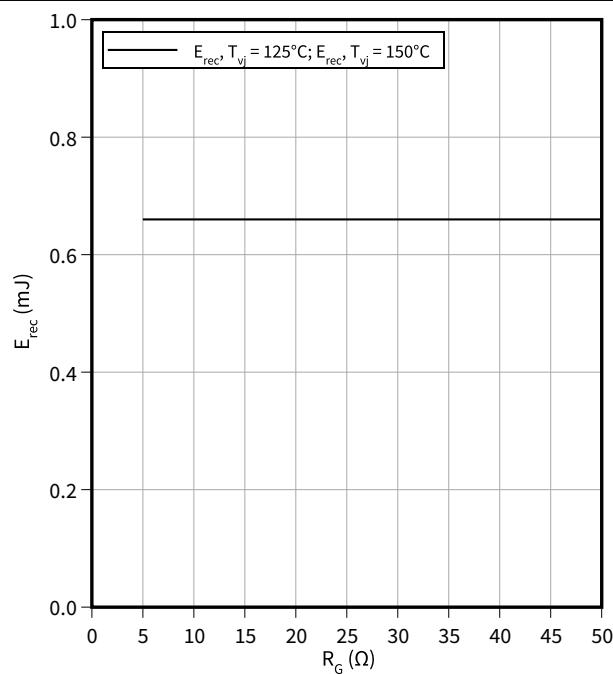
$R_G = 5 \Omega$, $V_R = 500 \text{ V}$



Switching losses (typical), Diode, D5 / D6

$$E_{rec} = f(R_G)$$

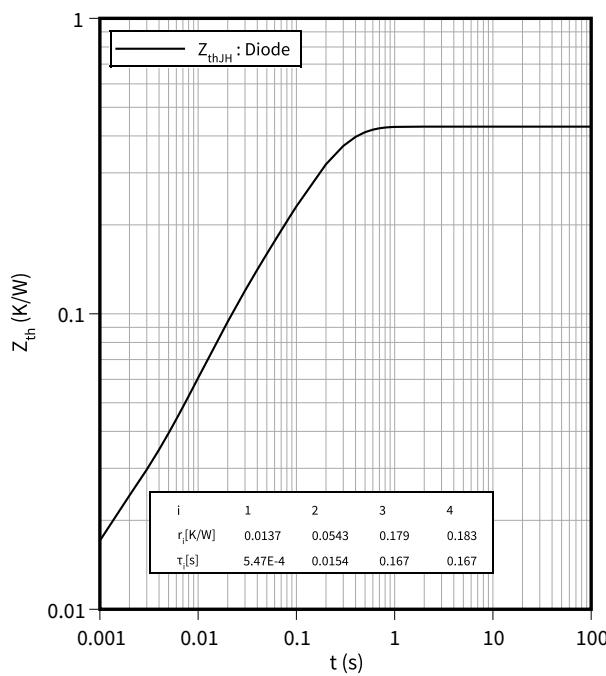
$I_F = 160 \text{ A}$, $V_R = 500 \text{ V}$



9 Characteristics diagrams

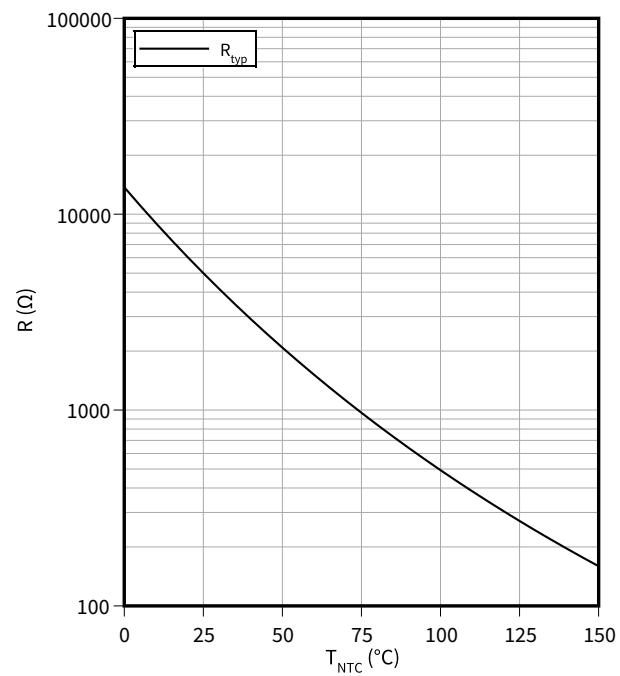
Transient thermal impedance, Diode, D5 / D6

$$Z_{th} = f(t)$$

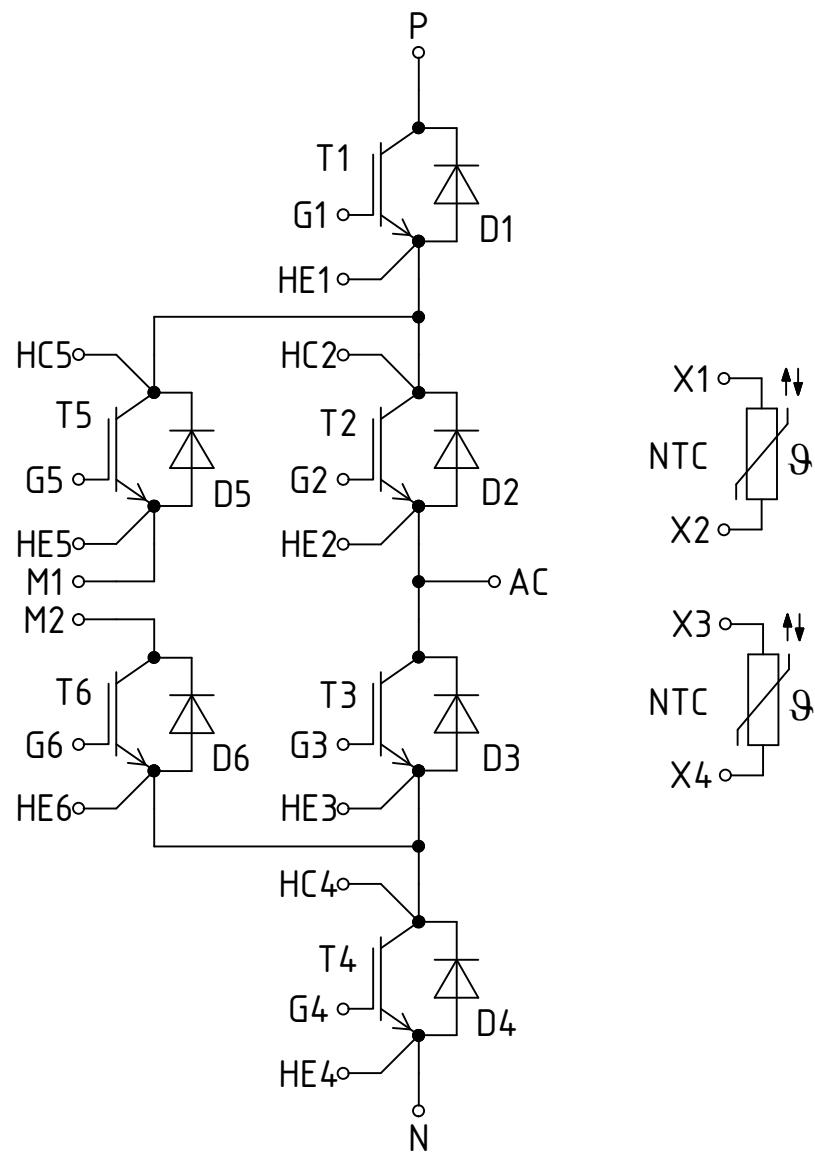


Temperature characteristic (typical), NTC-Thermistor

$$R = f(T_{NTC})$$



10 Circuit diagram



W001733365.04

Figure 1

11 Package outlines

11 Package outlines

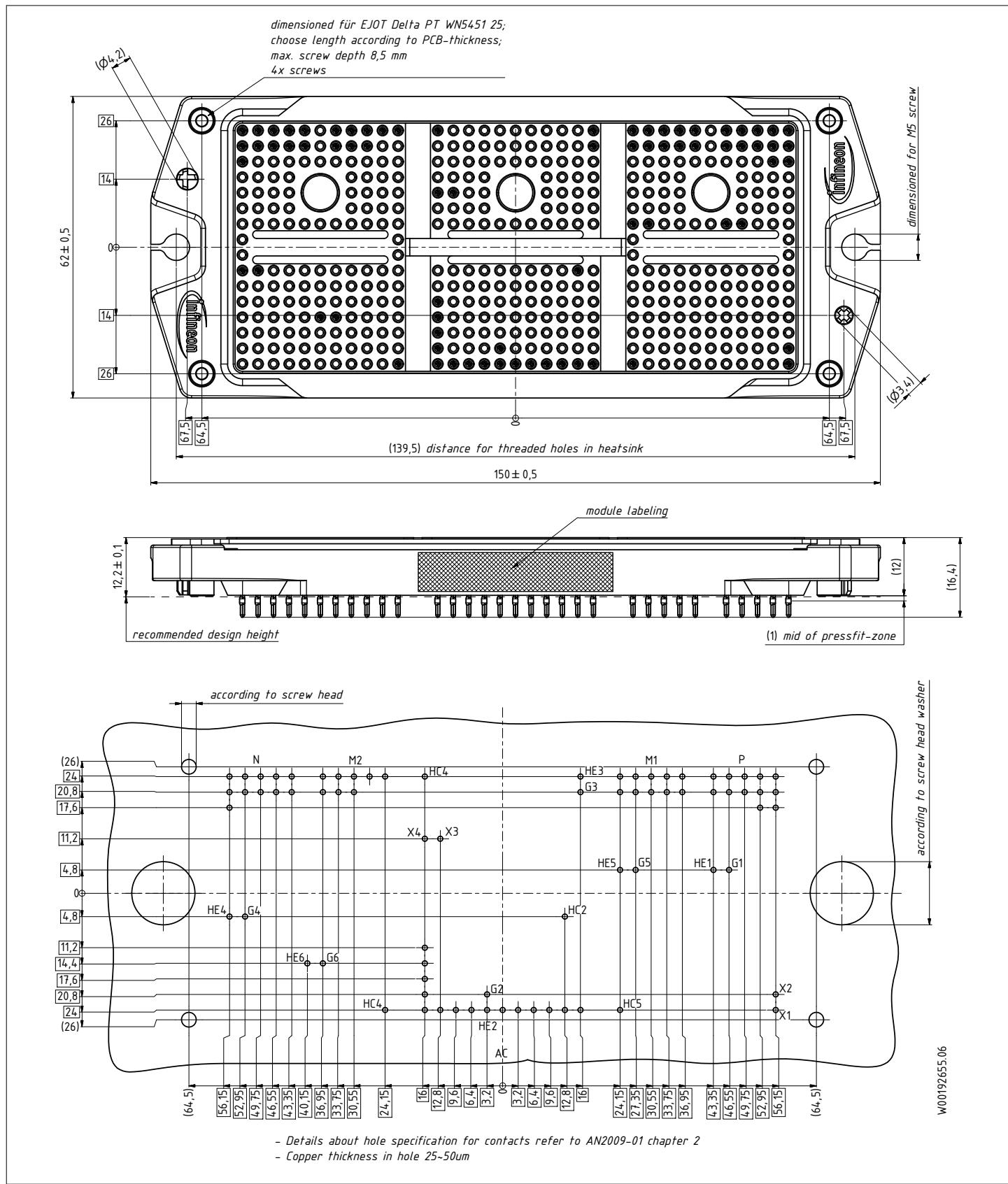


Figure 2

12 Module label code

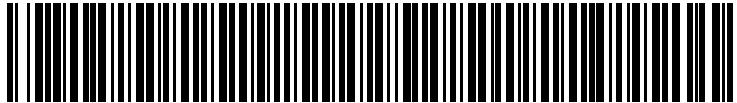
Module label code			
Code format	Data Matrix		Barcode Code128
Encoding	ASCII text		Code Set A
Symbol size	16x16		23 digits
Standard	IEC24720 and IEC16022		IEC8859-1
Code content	<p><i>Content</i></p> <p>Module serial number Module material number Production order number Date code (production year) Date code (production week)</p>	<p><i>Digit</i></p> <p>1 – 5 6 - 11 12 - 19 20 – 21 22 – 23</p>	<p><i>Example</i></p> <p>71549 142846 55054991 15 30</p>
Example			71549142846550549911530

Figure 3

Revision history

Revision history

Document revision	Date of release	Description of changes
0.10	2021-08-17	Target datasheet
1.00	2022-05-06	Final datasheet

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[FZ300R12KE3G](#) [FZ400R17KE3](#) [FZ400R17KE4](#) [FZ600R65KE3](#) [DF1000R17IE4D_B2](#) [APTGT75DA60T1G](#) [DZ800S17K3](#) [F12-25R12KT4G](#)
[F3L200R12W2H3_B11](#) [F3L300R12ME4_B22](#) [F3L75R07W2E3_B11](#) [F4-150R12KS4](#) [F475R07W1H3B11ABOMA1](#)
[FD1400R12IP4D](#) [FD400R12KE3_B5](#)